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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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# 5A SCHOTTKY BARRIER RECTIFIER POWERDI®

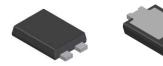
### **Features**

- Guard Ring Die Construction for Transient Protection
- High Surge Current Capability
- Low Leakage Current
- · Low Power Loss, High Efficiency
- For Use in High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- High Forward Surge Current Capability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

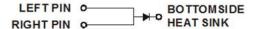
- Case: POWERDI<sup>®</sup>5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (§3)
- Polarity: See Diagram
- Weight: 0.094 grams (Approximate)

#### POWERDI®5



Top View

**Bottom View** 



Note: Pins Left & Right must be electrically connected at the printed circuit board.

### Ordering Information (Note 4)

Part Number	Case	Packaging
PDS560-13	POWERDI <sup>®</sup> 5	5,000/Tape & Reel
PDS560Q-13	POWERDI®5	5.000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

## Marking Information



S560 = Product Type Marking Code

O|| = Manufacturers' Code Marking

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 15 for 2015)

WW = Week Code (01 – 53)

K = Factory Designator



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	٧
RMS Reverse Voltage	V <sub>R(RMS)</sub>	42	V
Average Rectified Output Current	I <sub>O</sub>	5	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I <sub>FSM</sub>	150	Α

### **Thermal Characteristics**

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{ heta JS}$	_	2.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 5) $T_A = +25$ °C	$R_{\theta JA}$	95	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 6) $T_A = +25$ °C	$R_{ heta JA}$	70	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 7) $T_A = +25$ °C	$R_{\theta JA}$	50	_	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to	+150	°C

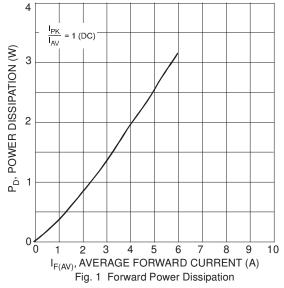
### **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

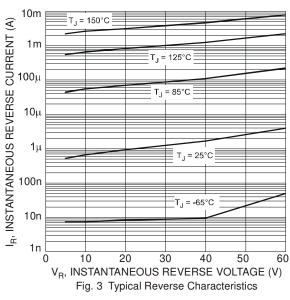
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	V <sub>(BR)R</sub>	60	_	_	V	$I_R = 0.2 \text{mA}$
		_	0.61	0.67	V	$I_F = 5A, T_S = +25^{\circ}C$
Forward Voltage	VF	_	0.54	0.60		$I_F = 5A, T_S = +125$ °C
Forward voilage	VF	_	0.71	0.77		$I_F = 8A, T_S = +25^{\circ}C$
		_	_	0.68		$I_F = 8A, T_S = +125$ °C
		_	4	150	μΑ	$T_S = +25^{\circ}C, V_R = 60V$
Reverse Leakage Current (Note 8)	I <sub>R</sub>	_	_	15	mΑ	$T_S = +100$ °C, $V_R = 60$ V
		_	2	30	mA	$T_S = +125$ °C, $V_R = 60$ V

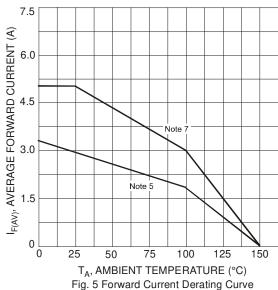
Notes:

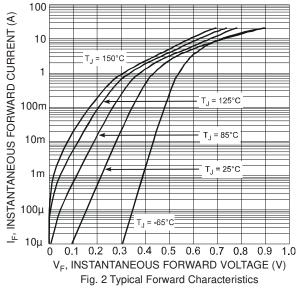
- FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
   Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
   Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
   Short duration pulse test used to minimize self-heating effect.

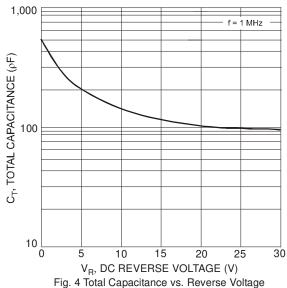


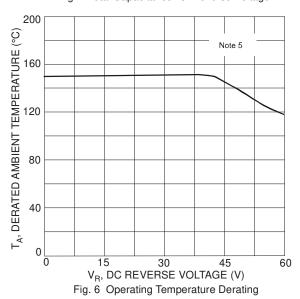








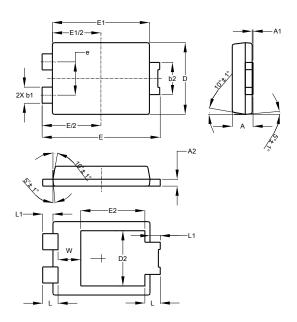






## **Package Outline Dimensions**

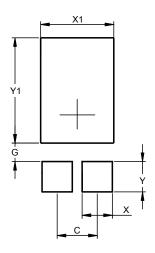
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



POWERDI <sup>®</sup> 5					
Dim	Min	Max	Тур		
Α	1.05	1.15	1.10		
A1	0.00	0.05			
A2	0.33	0.43	0.381		
b1	0.80	0.99	0.89		
b2	1.70	1.88	1.78		
D	3.90	4.05	3.966		
D2			3.054		
Е	6.40	6.60	6.504		
е			1.84		
E1	5.30	5.45	5.37		
E2	-	-	3.549		
L	0.75	0.95	0.85		
L1	0.50	0.65	0.57		
W	1.10	1.41	1.255		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.840
G	0.852
X	1.390
X1	3.360
Y	1.400
Y1	4.860



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